

Electronic Patent Application Fee Transmittal

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|---|---------------------------------------|--------------------|---------------|-----------------------------|
| Application Number: | 10534459 | | | |
| Filing Date: | 11-May-2005 | | | |
| Title of Invention: | Radiation sensitive resin composition | | | |
| First Named Inventor/Applicant Name: | Hiroshi Kurakata | | | |
| Filer: | Mark Sandler Weiner/Megumi Armstrong | | | |
| Attorney Docket Number: | 4918-0102PUS1 | | | |
| Filed as Large Entity | | | | |
| U.S. National Stage under 35 USC 371 | | Filing Fees | | |
| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
| Basic Filing: | | | | |
| Pages: | | | | |
| Claims: | | | | |
| Miscellaneous-Filing: | | | | |
| Petition: | | | | |
| Patent-Appeals-and-Interference: | | | | |
| Post-Allowance-and-Post-Issuance: | | | | |
| Extension-of-Time: | | | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
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| Miscellaneous: | | | | |
| Submission- Information Disclosure Stmt | 1806 | 1 | 180 | 180 |
| Total in USD (\$) | | | | 180 |